

3/18/05

03-23-2005

DJ

FORM PTO-1595
(Rev. 10/02)
OMD No. 0651-0011 (exp. 6/30/2005)



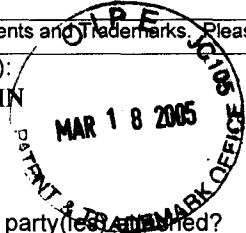
U.S. DEPARTMENT OF COMMERCE
Patent and Trademark Office

102964591

To the Honorable Commissioner of Patents and Trademarks, Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):
Hee-Bok KANG; Jin-Hong AHN

Additional name(s) of conveying party(ies) attached?
 No Yes



2. Name and address of receiving party(ies):
Name: **Hynix Semiconductor, Inc.**

Internal Address: _____

Street Address: **San 136-1, Ami-ri, Bubal-eub**

City: **Ichon-shi, Kyoungki-do** State: _____ ZIP: **467-860**

Country: **Republic of Korea**

Additional name(s) & address(es) attached? No Yes

3. Nature of Conveyance:
 Assignment Merger
 Security Agreement Change of Name
 Other _____

Execution Date: **12/17/2004**

4. Application number(s) or patent number(s):
If this document is being filed together with a new application, the execution date of the application is: _____

A. Patent Application No.(s) 11/030,558	B. Patent No.(s) _____ _____ _____ _____
---	--

Additional numbers attached? No Yes

5. Name and address of party to whom correspondence concerning document should be mailed:
Name: **Blakely, Sokoloff, Taylor & Zafman LLP**

Internal Address: _____

Street Address: **12400 Wilshire Boulevard
7th Floor**

City: **Los Angeles** State: **CA** ZIP: **90025**

6. Total number of applications and patents involved: **1**

7. Total Fee (37 CFR 3.41).....\$ **40.00**
 Enclosed
 Authorized to be charged to deposit account

8. Deposit Account Number:
02-2666
(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature.
To the best of my knowledge and belief, the foregoing is true and correct and any attached copy is a true copy of the original document.

03/22/2005 6TOM11 00000122 11030558
01 FC:8021 (40.00 DP)

Eric S. Hyman _____ **3/18/05**
Name of Person Signing Signature Date

Total number of pages including cover sheet, attachments, and document: **3**

Mail documents to be recorded with required cover sheet information to:
Mail Stop Assignment Recordation Services
Director of the US Patent and Trademark Office
P.O. Box 1450
Alexandria, VA 22313-1450

Docket No. 51876P786

PATENT
REEL: 016376 FRAME: 0123

ASSIGNMENT

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned,

KANG, Hee-Bok / AHN, Jin-Hong

Hereby sells, assigns, and transfers to:

Hynix Semiconductor, Inc.

a corporation of Republic of Korea, having a principal place of business at:

San 136-1, Ami-ri, Bubal-eub, Ichon-shi, Kyoungki-do 467-860, Republic of Korea

("Assignee"), and its successors, assigns and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent,

which has been executed by the undersigned concurrently herewith,

which was filed January 5, 2005 and assigned Serial No. 11/030,558.

and is entitled:

SEMICONDUCTOR MEMORY DEVICE WITH ON DIE TERMINATION
CIRCUIT

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be issued in the United States and all foreign countries on said improvements; and in and to all rights of priority resulting from the filing of said United States application;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date: 12.19, 2004

Kang Hee Bok

Name: KANG, Hee-Bok

Date: 12.19, 2004

Ahn Jin Hong

Name: AHN, Jin-Hong